



LIGITEK ELECTRONICS CO.,LTD.
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LED SMD



Lead-Free Parts

LG-170H-DGM-CT/T30

DATA SHEET

DOC. NO : QW0905-LG-170H-DGM-CT/T30

REV. : A

DATE : 10 - May. - 2017



Features:

1. Package in 8.0mm carrier tape on 7" diameter reel.
2. Compatible with automatic placement equipment.
3. Compatible with reflow solder process.

Descriptions:

1. The LG-170H SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
2. Besides, lightweight makes them ideal for miniature applications. etc.

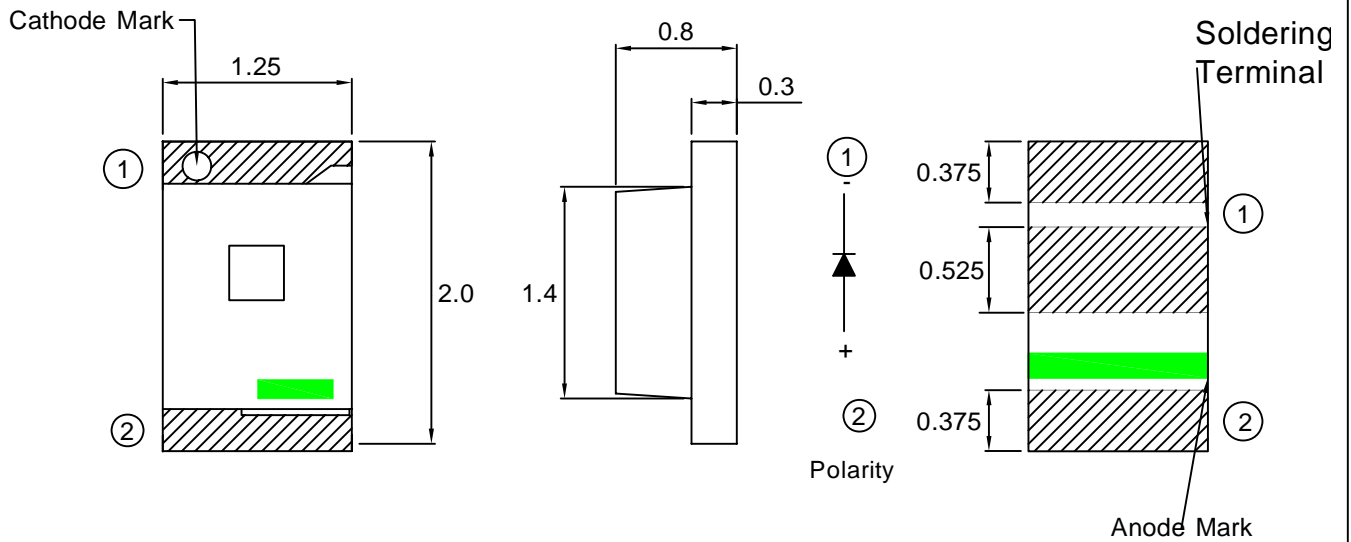
Applications:

1. Automotive : backlighting in dashboard and switch.
2. Telecommunication : indicator and backlighting in telephone and fax.
3. Flat backlight for LCD, switch and symbol
4. General use.

Device Selection Guide:

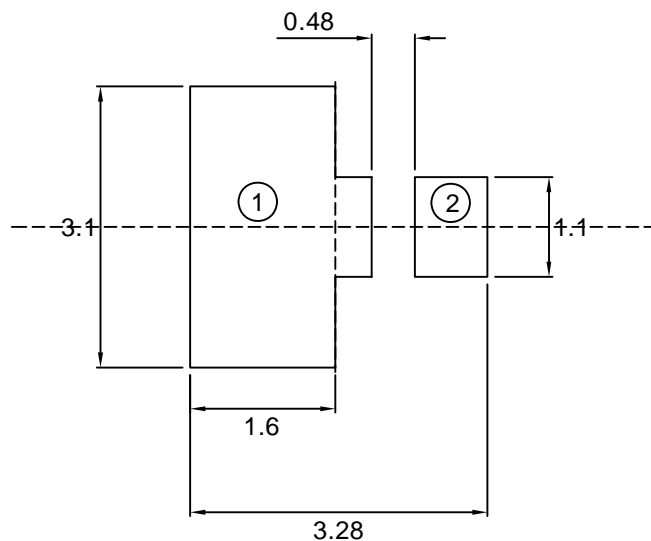
PART NO	MATERIAL	COLOR	
		Emitted	Lens
LG-170H-DGM-CT/T30	InGaN	Green	Water Clear

Package Dimensions



Note : 1.All dimension are in millimeter tolerance is $\pm 0.1\text{mm}$ unless otherwise noted.
2.Specifications are subject to change without notice.

Recommended Soldering Pad Dimensions



Note : The tolerances unless mentioned is $\pm 0.1\text{mm}$, Angle ± 0.5 . Unit=mm.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Ratings	UNIT
Power Dissipation	PD	108	mW
Peak Forward Current Duty 1/10@10KHz	IFP	100	mA
Forward Current	IF	30	mA
Reverse Current @5V	Ir	50	μA
Electrostatic Discharge	ESD	500	V
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C

Typical Electrical & Optical Characteristics (Ta=25°C)

Items	Symbol	Min.	Typ.	Max.	UNIT	CONDITION
Luminous Intensity	Iv	500	950	----	mcd	IF=30mA
Dominant Wavelength	λD	----	525	----	nm	IF=30mA
Spectral Line Half-Width	△λ	----	36	----	nm	IF=30mA
Forward Voltage	V _F	2.8	----	3.6	V	IF=30mA
Viewing Angle	2θ 1/2	----	140	----	deg	IF=30mA

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.
2. The luminous intensity data did not including ±15% testing tolerance.
3.The dominant wavelength data did not including ±1nm testing tolerance.

Luminous Intensity Classification

BIN CODE	Iv(mcd) at 30mA	
	Min.	Max.
U	500	800
V-1	800	1000
V-2	1000	1250
W-1	1250	1600

Dominant Wavelength Classification

BIN CODE	λD (nm) at 30mA	
	Min.	Max.
1O	519	522
1P	522	525
1Q	525	528
1R	528	531

Forward Voltage Classification

BIN CODE	Vf(v) at 30mA	
	Min.	Max.
1	2.8	3
2	3	3.2
3	3.2	3.4
4	3.4	3.6

Typical Electro-Optical Characteristics Curve DGM CHIP

Fig.1 Forward current vs. Forward Voltage

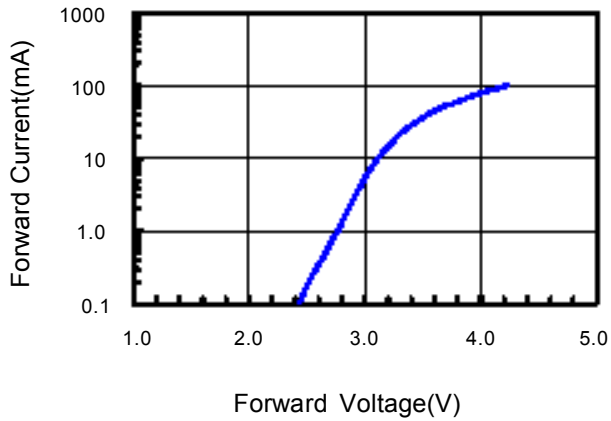


Fig.2 Relative Intensity vs. Forward Current

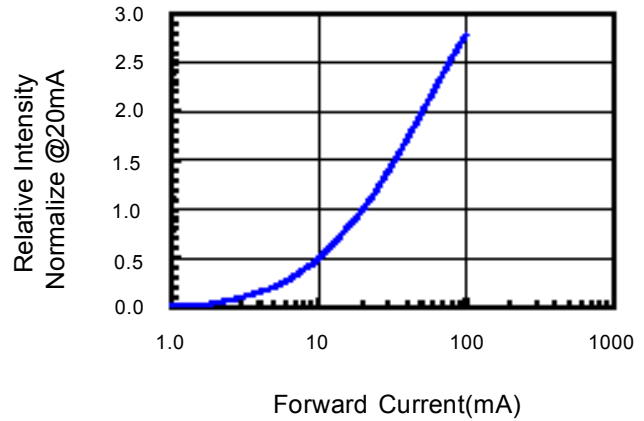


Fig.3 Forward Current vs. Temperature

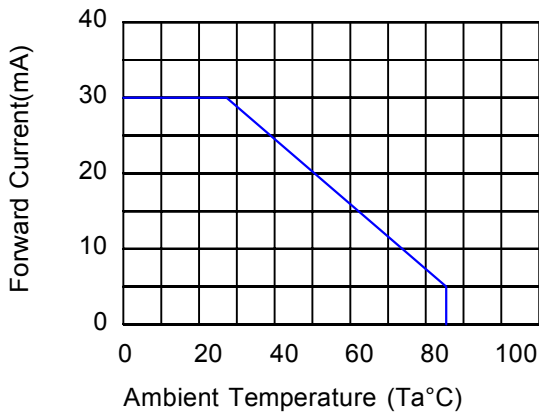


Fig.4 Relative Intensity vs. Temperature

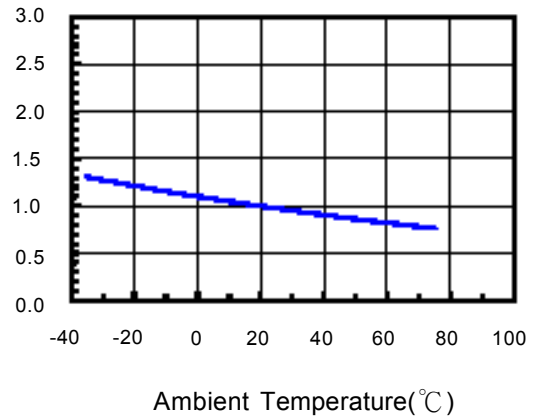


Fig.5 Relative Intensity vs. Wavelength

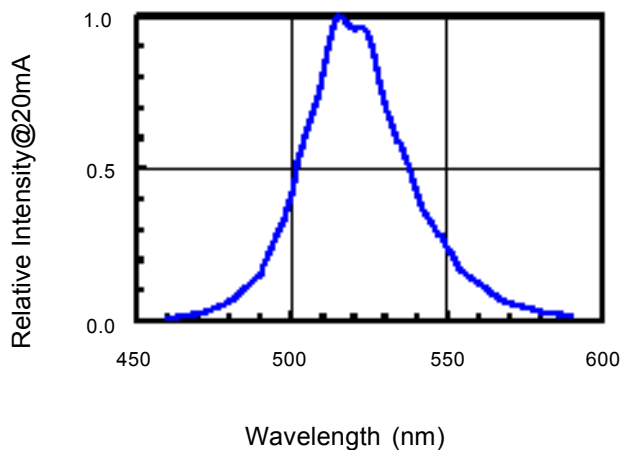
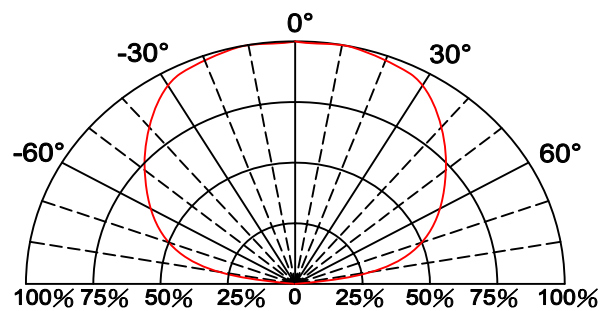
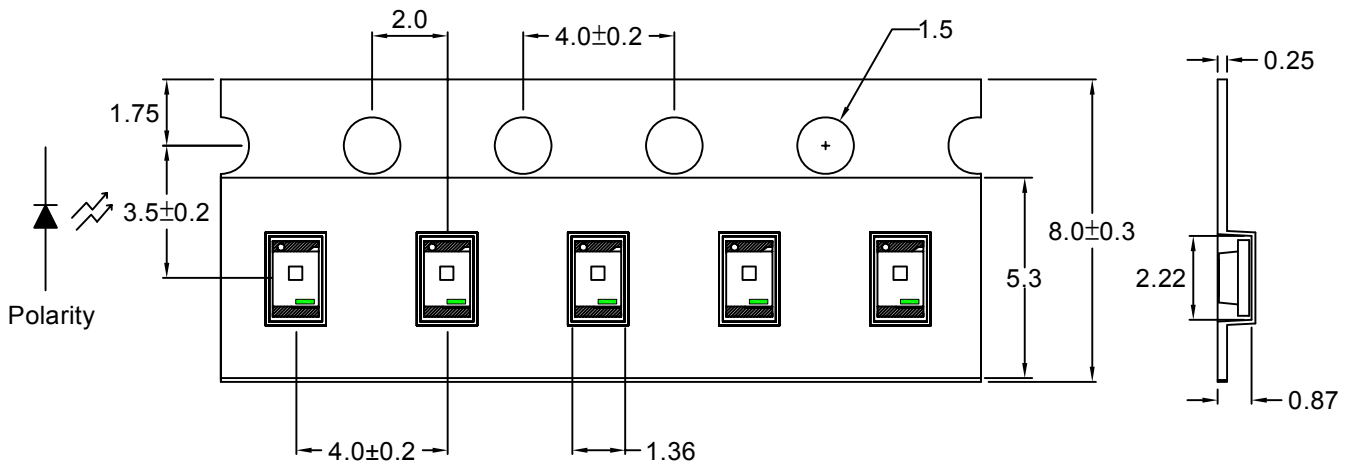


Fig.6 Directive Radiation

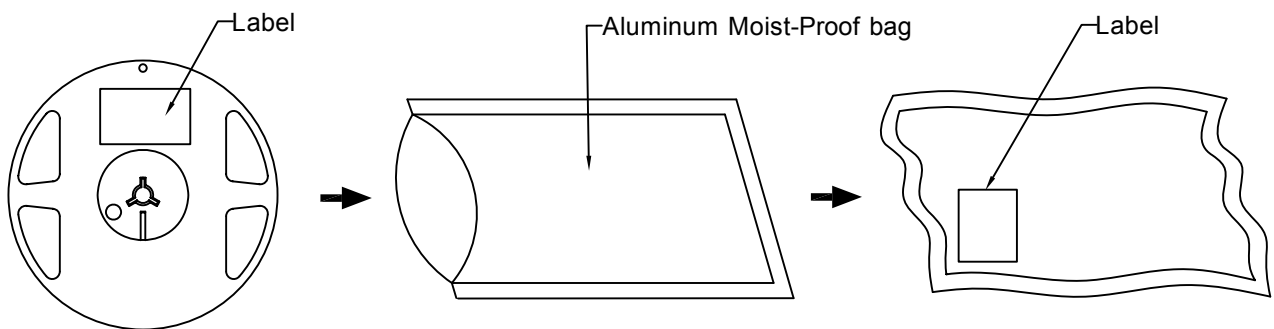


Carrier Type Dimensions









Note : The tolerances unless mentioned is $\pm 0.1\text{mm}$, Angle ± 0.5 . Unit=mm.

• Packing Specifications



Part No.	Description	Quantity/Reel
LG-170H-DGM-CT/T30	8.0mm tape,7"reel	4000 devices

Label Explanation

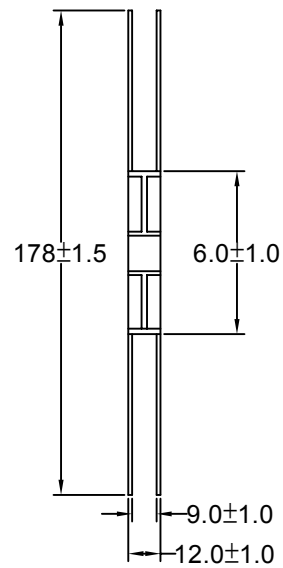
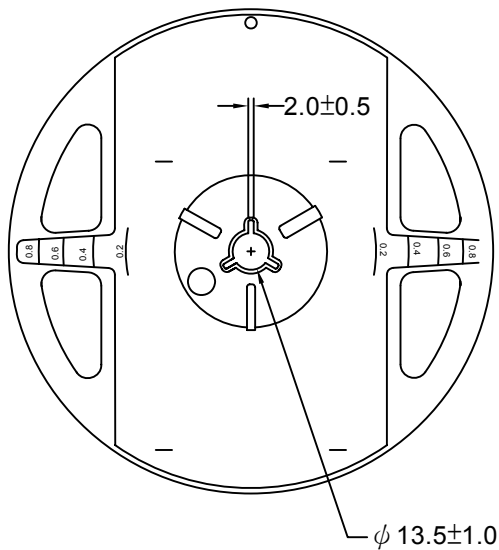
	LIGITEK ELECTRONICS CO., LTD.	
		
	PART :	LG-170H-DGM-CT/T30
		
	LOT :	GS11690168
		
QTY(PCS):	4000	
		
BIN/HUE :	U/1P	VF:3.0-3.2

BIN : Luminous Intensity

HUE : Dominant Wavelength

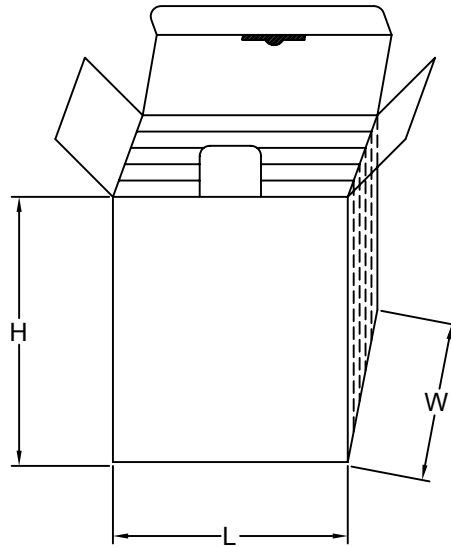
VF : Forward Voltage

Reel Dimensions

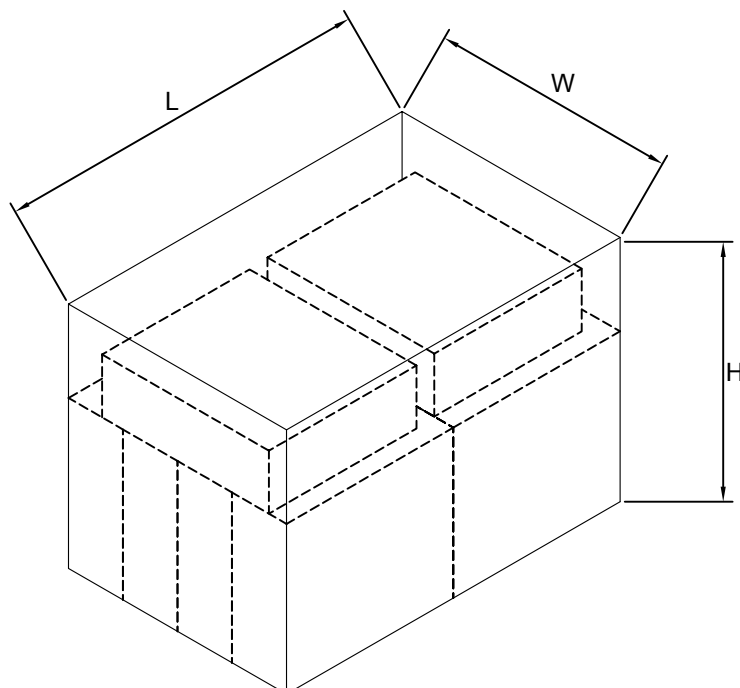


Box Explanation

1. 5 BAG / INNER BOX
2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm

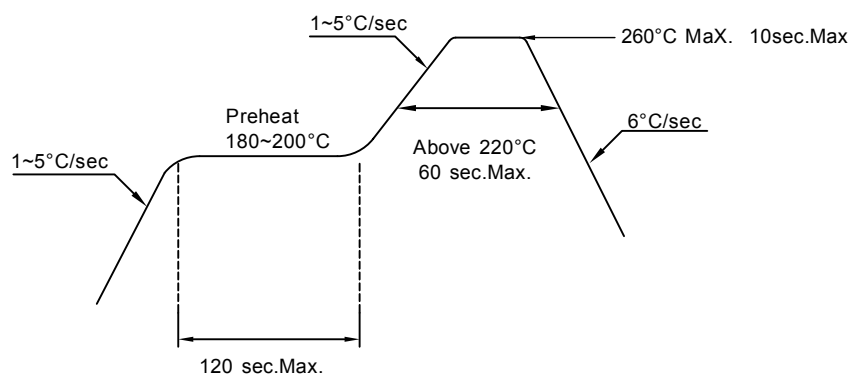


3. 10 INNER BOXES / CARTON
4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm



Recommended Soldering Conditions**1. Hand Solder**

Basic spec is $\leq 280^{\circ}\text{C}$ 3 sec one time only.

2. PB-Free Reflow Solder**Note:**

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering,do not put stress on the LEDs during heating.
- 3.After soldering,do not warp the circuit board.

Precautions For Use:**Storage time:**

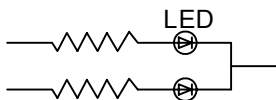
1. Calculated shelf life before opening is 12 months at $< 30^{\circ}\text{C}$ and $< 90\%$ relative humidity (RH)
2. After bag is opened, devices which will be subjected to reflow soldering or other high temperature processes must be
 - a) Assembled within 168 hours in an environment of $\leq 30^{\circ}\text{C} / 60\%$ RH, or
 - b) Stored at ambient of 10% RH or less
3. Devices are required baking before assembly if:
 - a) Humidity Indicator Card reads $>10\%$ (for level 2a -5a) or $>60\%$ (for level 2) at ambient temperature $23 \pm 5^{\circ}\text{C}$
 - b) 2.a) or 2.b) doesn't meet
4. If baking is required, devices should be baked for >72 hours at $60 \pm 5^{\circ}\text{C} / 5\%$ RH. Performing baking only once, and using the baked devices within 72 hours.

Drive Method:

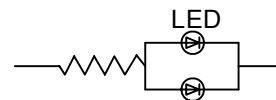
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations than could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

Reliability Test:

Classification	Test Item	Test Condition	Sample Size
Endurance Test	Operating Life Test	1.Ta=25°C 2.If=30mA 3.t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature Storage Test	1.Ta=100°C±5°C 2.t=1000 hrs (-24hrs,+72hrs)	22
	Low Temperature Storage Test	1.Ta=-40°C±5°C 2.t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature High Humidity Storage Test	1.Ta=85°C 2.RH=85% 3.t=1000hrs(-24hrs,+72hrs)	22
Environmental Test	Thermal Shock Test	1.Ta=100°C±5°C ~ -40°C±5°C 20min/ 10sec / 20min 2.total 100 cycles	22
	Temperature Cycling	1.100°C±5°C ~ -40°C±5°C 30mins / 5mins / 30mins 2.100 Cyeles	22
	IR Reflow	1.T=260°C Max. 10sec.Max. 2. 6 Min	22